2.4 and 2.4, 5 GHz Ceramic and MID Chip Antennas



2.4 and 2.4, 5 GHz Ceramic and MID Chip Antennas offer outstanding performance, design flexibility and easy integration, making them ideal for various markets and applications

Features and Advantages

Product and Technical Differences												
Attribute	2.4, 5GHz Ceramic Chip Edge-Mount, Antenna (Series 211964)			2.4, 5GHz Ceramic Chip Corner-Mount, Antenna (Series 206774)			2.4, 5 GHz SMT MID Chip Antenna (Series 146175)		2.4,5GHz SMT Ceramic Antenna (Series 206514)		2.4 GHz SMT MID Chip Antenna (Series 47948)	2.4 GHz SMT Ceramic Antenna (Series 206513)
Size	3.20(L) by 1.60(W) by 1.20(H) mm			3.20 by 1.60 by 0.65mm			5.00(L) by 3.00(W) by 4.00(H) mm		4.00 by 3.00 by 4.00mm		3.00 by 3.00 by 4.00mm	3.00 by 3.00 by 4.00mm
PCB Keep-out	6.00(L) by 4.00(W)mm			5.90 by 5.85mm			6.00(L) by 4.00(W)mm		6.60 by 4.70mm		4.00 by 4.00mm	4.00 by 4.00mm
Material	Ceramic			Ceramic			MID-LDS		Ceramic		MID-LDS	Ceramic
Antenna Type	Loop			LTCC			Loop		Loop		Monopole	Monopole
Frequency Range	*2.4 to 2.5 GHz	**2.4 to 2.5 GHz	**5.15 to 5.85 GHz	*2.4 to 2.5 GHz	**2.4 to 2.5GHz	**5.15 to 5.85 GHz	2.4 GHz	5 GHz	2.4 GHz	5 GHz	2.4 to 2.5 GHz	2.4 GHz
Return Loss	<-6 dB	<-5 dB	<-5 dB	<-10dB	<-7dB	<-10dB	<	6 dB	<-8 dB	<-5 dB	<-7 dB	<-6 dB
Peak Gain	2.7dBi	2.1dBi	2.2dBi	1.9dBi	1.7dBi	1.8dBi	3 dBi	4.2 dBi	3.5 dBi	6.2 dBi	3.3 dBi	3.0 dBi
Total Efficiency	>80% >70% >65%		>60%		70% for both 2.4 and 5 GHz		>75%		>70%	>55%		
Polarization	Linear			Linear			Linear		Linear		Linear	Linear
Operating Temperature	-40 to +85°C			-40 to +85°C			-40 to +125°C		-40 to +85°C		-40 to +125°C	-40 to +125°C
		and and du rating effic		Miniature RF perfor	in size bu mance	t big in	Small clearance zone; high RF performance; dual-band; halogen-free Miniature in size and low in cost		ze and low	Miniature in size but big in RF performance	Miniature and identical in size with series 47948	
Key Advantages	Symmetrical radiator design offers significant design flexibility by allowing reversed lateral placement on the PCB without affecting radiation pattern or performance			Small size, low cost, corner mount			Laser Direct Structuring (LDS)-formed circuitry yields high, consistent RF performance, leveraging the excellent laser structuring precision, speed, accuracy and repeatability of LDS technology		Cost-economical		Environmentally sustainable halogen-free LDS-MID housing withstands high reflow temperatures during assembly processing	Cost-economical

^{*} Config. 1, single band ** Config. 2, dual band

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Applications

Connected Home

Security and Surveillance

Home Automation

Home Streaming Entertainment

Smart Appliances

Energy and Utilities

Wireless Infrastructure

Wireless Solutions

Telecommunications/Networking

Infrastructure/Networking

Commercial Vehicles

Networking



Specifications

REFERENCE INFORMATION

Packaging: Tape and Reel Designed In: Millimeters

RoHS: Yes Halogen Free: Yes Glow Wire Compliant: No

ELECTRICAL

RF Power (Watt): 2

Return Loss: Refer to Product Specifications Average Total Radiation Efficiency(%): Refer to

Product Specifications

Peak Gain (dBi): Refer to Product Specifications

Input Impedance (ohms): 50

MECHANICAL

Refer to Product Specifications

PHYSICAL

Material: Ceramic

(206513, 211964, 206514, 206774)

LCP-LDS (146175, 147948)

Plating:

Silver (Ag) (206513, 211964, 206514, 206774)

Copper (Cu), Nickel (Ni), Gold (Au) (146175, 47948)

Operating Temperature: -40 to +125°C -40 to +85°C (211964, 206514, 206774)

Ordering Information

Series No.	Frequency Band (MHz)	Dimensions (mm)		
<u>206513</u>	2.4 to 2.5	2.00(L) by 2.00(M) by 4.00(L)		
<u>47948</u>	2.4 t0 2.5	3.00(L) by 3.00(W) by 4.00(H)		
<u>206514</u>		3.00(L) by 4.00(W) by 400(H)		
<u>146175</u>	2.4 to 2.5 and	5.00(L) by 3.00(W) by 4.00(H)		
211964	5.15 to 5.85	3.20(L) by 1.60(W) by 1.20(H)		
<u>206774</u>		3.20 by 1.60 by 0.65mm		